



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20250413001.2
Adding TIEM-PR as additional wafer probe site
Change Notification / Sample Request

Date: April 14, 2025
To: MOUSER PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team
SC Business Services

20250413001.2
Change Notification / Sample Request
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TCAN1042GDRBRQ1	TCAN1042GDRBRQ1
TCAN1145DYRQ1	NULL
TCAN3403DRQ1	NULL
TLIN10285DDARQ1	NULL
TCAN1042HGVDRBRQ1	TCAN1042HGVDRBRQ1
TCAN1042GDRBRQ1	595-TCAN1042GDRBRQ1
TCAN1043ADRQ1	NULL
ISO1042QDWQ1	ISO1042QDWQ1
TCAN3403DRBRQ1	NULL
TCAN1145DRQ1	NULL
TCAN1044AEVDDFRQ1	NULL
TCAN1042HGVDRQ1	TCAN1042HGVDRQ1
TCAN1043GDRQ1	NULL
TCAN1463DYRQ1	NULL
ISO1042QDWVRQ1	ISO1042QDWVRQ1
TCAN1042HDRBTQ1	TCAN1042HDRBTQ1
TLIN2021ADRQ1	NULL
TLIN1021ADRQ1	NULL
TCAN1462VDRQ1	NULL
TCAN3404DDFRQ1	NULL
TLIN1021ADDFRQ1	NULL
TCAN1046AVDRQ1	NULL
TCAN1463DRQ1	NULL
TCAN1042GDRQ1	TCAN1042GDRQ1
TCAN1042HDRQ1	TCAN1042HDRQ1
TCAN1043ADYRQ1	NULL
TCAN3403DDFRQ1	NULL
TLIN2021ADDFRQ1	NULL
TCAN1042GDRQ1	595-TCAN1042GDRQ1
TCAN1042DRBRQ1	TCAN1042DRBRQ1
TCAN1042VDRQ1	TCAN1042VDRQ1
TCAN1042VDRBRQ1	TCAN1042VDRBRQ1
TCAN1043DRQ1	595-TCAN1043DRQ1
TCAN1046AVDYRQ1	NULL
TCAN1048AVDRQ1	NULL
TCAN1043DQ1	TCAN1043DQ1
TLIN10283DRQ1	NULL
TCAN1042GDRBTQ1	595-TCAN1042GDRBTQ1
TCAN1043DMTRQ1	NULL
TCAN1042DRQ1	TCAN1042DRQ1
TCAN1043DRQ1	TCAN1043DRQ1
TCAN1043HGDQ1	TCAN1043HGDQ1
TCAN1057ADDFRQ1	595-TCAN1057ADDFRQ1
TCAN1462DRQ1	NULL
TCAN1044AVDDFRQ1	NULL
TCAN1042HGVDRBTQ1	TCAN1042HGVDRBTQ1
TCAN3404DRQ1	NULL

TCAN1043DMTTQ1	TCAN1043DMTTQ1
TCAN1057AVDDFRQ1	NULL
TCAN1043HDQ1	TCAN1043HDQ1
TCAN1042GVDRBRQ1	NULL
TCAN1044ADDFRQ1	NULL
TCAN1042GVDRQ1	TCAN1042GVDRQ1
TCAN1042VDRBTQ1	TCAN1042VDRBTQ1
TCAN1042GVDRBTQ1	TCAN1042GVDRBTQ1
TCAN1042HGDRBTQ1	TCAN1042HGDRBTQ1
ISO1042BQDWQ1	ISO1042BQDWQ1
TCAN1146DRQ1	NULL
TLIN10285DRQ1	NULL
TCAN3404DRBRQ1	NULL
TCAN1043GDQ1	TCAN1043GDQ1
TCAN1042GDRBTQ1	TCAN1042GDRBTQ1
TCAN1043HGDRQ1	595-TCAN1043HGDRQ1
TCAN1146DYRQ1	NULL
TCAN1042HVDRQ1	TCAN1042HVDRQ1
TCAN1044AEVDRQ1	NULL

Technical details of this Product Change follow on the next page(s).

PCN Number:	20250413001.2			PCN Date:	April 14, 2025								
Title:	Adding TIEM-PR as additional wafer probe site												
Customer Contact:	Change Management team		Dept:	Quality Services									
Proposed 1st Ship Date:	October 11, 2025		Estimated Sample Availability:	N/A									
Change Type:													
☐	Assembly Site	☐	Design	☐	Wafer Bump Material								
☐	Assembly Process	☐	Data Sheet	☐	Wafer Bump Process								
☐	Assembly Materials	☐	Part number change	☐	Wafer Fab Site								
☐	Mechanical Specification	☒	Test Site	☐	Wafer Fab Material								
☐	Packing/Shipping/Labeling	☐	Test Process	☐	Wafer Fab Process								
PCN Details													
Description of Change:													
Texas Instruments is pleased to announce TIEM-PR as additional wafer probe site for the devices listed below to support high volume ramps.													
<table border="1"> <thead> <tr> <th></th> <th>Current</th> <th>New</th> </tr> </thead> <tbody> <tr> <td>Probe Site</td> <td>TI CDAT (CD-PR)</td> <td>TI Melaka (TIEM-PR)</td> </tr> </tbody> </table>							Current	New	Probe Site	TI CDAT (CD-PR)	TI Melaka (TIEM-PR)		
	Current	New											
Probe Site	TI CDAT (CD-PR)	TI Melaka (TIEM-PR)											
Test coverage, insertions, conditions will remain consistent with current testing.													
Reason for Change:													
Continuity of supply.													
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):													
None													
Impact on Environmental Ratings:													
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.													
<table border="1"> <thead> <tr> <th>RoHS</th> <th>REACH</th> <th>Green Status</th> <th>IEC 62474</th> </tr> </thead> <tbody> <tr> <td>☒ No Change</td> <td>☒ No Change</td> <td>☒ No Change</td> <td>☒ No Change</td> </tr> </tbody> </table>						RoHS	REACH	Green Status	IEC 62474	☒ No Change	☒ No Change	☒ No Change	☒ No Change
RoHS	REACH	Green Status	IEC 62474										
☒ No Change	☒ No Change	☒ No Change	☒ No Change										
Changes to product identification resulting from this PCN:													
None													
Product Affected:													
TCAN1042HDRQ1	TCAN3403DDFRQ1	TCAN1042GDRBRQ1											
TCAN1042HGDRBTQ1	TCAN1042GDRBQ1	TCAN1042DRBTQ1											
TCAN1042GDRBTQ1	TCAN1042GDRQ1	TCAN1043GDMTRQ1											
TCAN1042DRQ1	TCAN1043HGDMTRQ1	TCAN1043HDQ1											
TCAN1042GVDRBTQ1	TCAN1043HDMTTQ1	TCAN1043DMTRQ1											
TCAN1042VDRBRQ1	TCAN1043HDMTRQ1	SN1043HNWFDMTQ1											
SN2004057VDRBRQ1	TCAN1043HDRQ1	TCAN1043DRQ1											
TCAN1463DRQ1	TCAN1043DQ1	TCAN1462VDRQ1											
ISO1042BQDWQ1	TCAN1145DRQ1	SN1044VDRQ1											
TCAN3403DRQ1	TCAN1042HVDRBRQ1	TCAN1042DRBRQ1											
TCAN1042HGDRBRQ1	TCAN1057ADDFRQ1	TCAN3404DRQ1											
TCAN1043HGDRQ1	TCAN1048AVDRQ1	SN1911033DRBRQ1											
TCAN1043GDMTTQ1	TCAN1044VDDFRQ1	SN1043HGNWFDMTQ1											
TCAN1042GVDRQ1	SN1044DRBRQ1	TCAN1043GDQ1											

TCAN1462VDDFRQ1	TCAN3404DDFRQ1	TCAN1042HGVDRQ1
TCAN1462DRQ1	TCAN1042HDRBTQ1	TCAN1042HGVDRBRQ1
TCAN1057AVDDFRQ1	TCAN1043HGDMTTQ1	TCAN1042HVDRBTQ1
TLIN10285DDARQ1	TCAN1043DMTTQ1	TCAN1042VDRBTQ1
TLIN1021ADRQ1	TCAN1145DYRQ1	SN1044DRQ1
TCAN1042HGDRQ1	TCAN1042HVDRQ1	SN1044VDRBRQ1
TCAN1043HGDQ1	TCAN1057AEVDRQ1	TLIN2021ADDFRQ1
PSN1043HGNWFDMTQ1	TCAN1046ADRQ1	TCAN1042HDRBRQ1
TCAN1042VDRQ1	TCAN1044AVDDFRQ1	SN1043GNWFDMTQ1
TCAN1462DDFRQ1	TCAN1044AEVDRQ1	TCAN1043GDRQ1
TCAN1043ADYRQ1	TCAN1057DRBQ1	SN1043NWFDMTQ1
TCAN1043ADRQ1	TCAN1146DRQ1	TCAN1042GVDRBRQ1
TLIN10285DRQ1	TCAN1146DYRQ1	TCAN1042HGVDRBTQ1
TCAN1463DYRQ1	TLIN10283DRQ1	TCAN1044AEVDDFRQ1
TLIN1021ADDFRQ1	TLIN10283DDARQ1	TCAN1046AVDRQ1
SN1021DRBRQ1	TLIN2021ADRQ1	TCAN1046AVDYRQ1
TLIN2021ADRBRQ1	ISO1042QDWVRQ1	TCAN1044ADDFRQ1
TCAN3404DRBRQ1	TCAN3403DRBRQ1	ISO1042QDWQ1

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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